



Honeywell

R-22 ALLOCATION: Find the Right Refrigerant Solution

What Has Changed?

On December 30, 2011 the EPA published a proposed rule for the management of HCFC-22 (R-22) Production and Consumption Allowances for 2012-2014. The proposed rule aims to decrease annual R-22 consumption allocations relative to the EPA's December 2009 final rule.

The previous rule allocated 100M lbs. for 2011 and planned to step down the allocations to 90M lbs. in 2012. In its December 2011 proposed rule, EPA contemplates reducing the baseline for allowances to a level between 55M and 80M lbs., a significant reduction from the allocation rule that is in place today.

The EPA has indicated that a new final rule, which is expected to be issued later this year following a 30-day comment period and the EPA's review and analysis of any comments received, will specify the exact reduction percentage relative to the 2009 Final Rule.

How Can Honeywell Help?

As R-22 supplies become more expensive and supplies tighten, many of our customers will be looking for alternatives to R-22 to retrofit their systems. At Honeywell, we have a wide range of non-ozone-depleting alternatives that are not subject to a phase-out. We are able and ready to offer our assistance to help you determine which of these alternatives will best meet your needs, and assist you in securing adequate supply of those products. The chart below will help you get started.

	Air Conditioning	Refrigeration
Blends	Genetron® 407C Genetron® 422D	Genetron® 404A (R-404A) Genetron® 407C (R-407C) Genetron® Performax™ LT (R-407F) Genetron® 422D (R-422D)
Azeotropes	Genetron® AZ-20® (R-410A) (New Equipment)	Genetron® AZ-50® (R-507) (Suitable for Flooded Systems)

At Honeywell, we know you have a choice of refrigerant supplier. We appreciate your business and look forward to working with you to find the right refrigerant solution.

For more information, visit www.genetron.com

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